

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









Important notice

Dear Customer,

On 7 February 2017 the former NXP Standard Product business became a new company with the tradename **Nexperia**. Nexperia is an industry leading supplier of Discrete, Logic and PowerMOS semiconductors with its focus on the automotive, industrial, computing, consumer and wearable application markets

In data sheets and application notes which still contain NXP or Philips Semiconductors references, use the references to Nexperia, as shown below.

Instead of http://www.nxp.com, http://www.nxp.com, http://www.nexperia.com, http://www.nexperia.com)

Instead of sales.addresses@www.nxp.com or sales.addresses@www.semiconductors.philips.com, use salesaddresses@nexperia.com (email)

Replace the copyright notice at the bottom of each page or elsewhere in the document, depending on the version, as shown below:

- © NXP N.V. (year). All rights reserved or © Koninklijke Philips Electronics N.V. (year). All rights reserved

Should be replaced with:

- © Nexperia B.V. (year). All rights reserved.

If you have any questions related to the data sheet, please contact our nearest sales office via e-mail or telephone (details via **salesaddresses@nexperia.com**). Thank you for your cooperation and understanding,

Kind regards,

Team Nexperia

74LVC16245A; 74LVCH16245A

16-bit bus transceiver with direction pin; 5 V tolerant; 3-state

Rev. 12 — 13 February 2012

Product data sheet

1. General description

The 74LVC16245A; 74LVCH16245A are 16-bit transceivers featuring non-inverting 3-state bus compatible outputs in both send and receive directions. The device features two output enable (nOE) inputs for easy cascading and two send/receive (nDIR) inputs for direction control. nOE controls the outputs so that the buses are effectively isolated. This device can be used as two 8-bit transceivers or one 16-bit transceiver.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices in mixed 3.3 V and 5 V applications.

The 74LVCH16245A bus hold on data inputs eliminates the need for external pull-up resistors to hold unused inputs.

2. Features and benefits

- 5 V tolerant inputs/outputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- MULTIBYTE flow-through standard pin-out architecture
- Low inductance multiple power and ground pins for minimum noise and ground bounce
- Direct interface with TTL levels
- High-impedance when $V_{CC} = 0 \text{ V}$
- All data inputs have bus hold (74LVCH16245A only)
- Complies with JEDEC standard:
 - ◆ JESD8-7A (1.65 V to 1.95 V)
 - ◆ JESD8-5A (2.3 V to 2.7 V)
 - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-B exceeds 200 V
 - ◆ CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

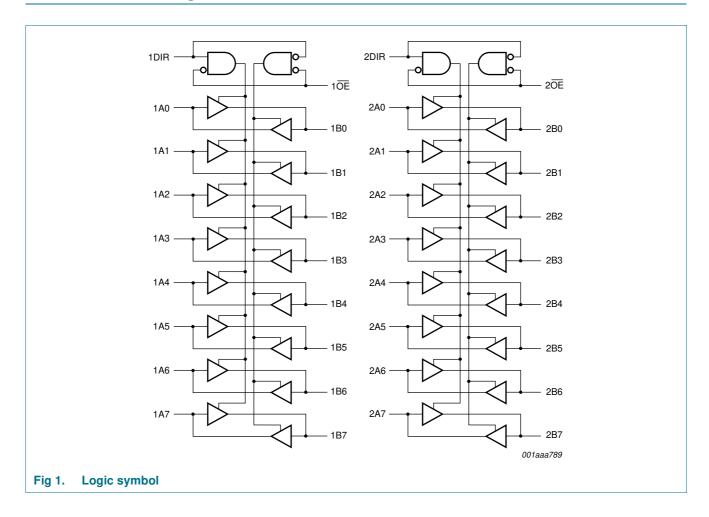


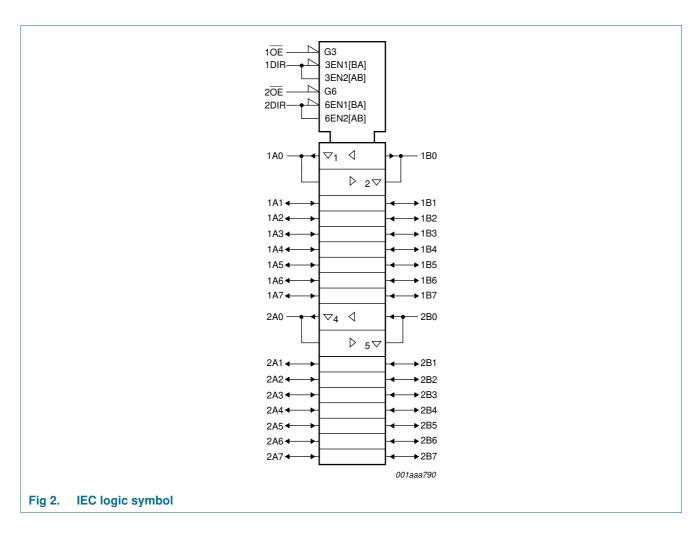
3. Ordering information

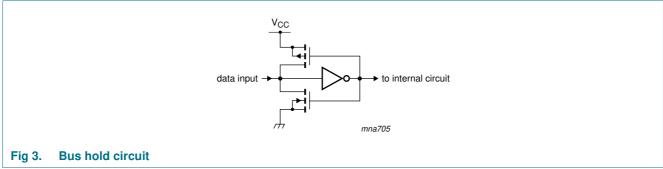
Table 1. Ordering information

Type number	Temperature range	Package	Package							
		Name	Description	Version						
74LVC16245ADL	–40 °C to +125 °C	SSOP48	plastic shrink small outline package; 48 leads;	SOT370-1						
74LVCH16245ADL			body width 7.5 mm							
74LVC16245ADGG	–40 °C to +125 °C	TSSOP48	plastic thin shrink small outline package;	SOT362-1						
74LVCH16245ADGG			48 leads; body width 6.1 mm							
74LVC16245AEV	–40 °C to +125 °C	VFBGA56	plastic very thin fine-pitch ball grid array package;	SOT702-1						
74LVCH16245AEV			56 balls; body $4.5 \times 7 \times 0.65$ mm							
74LVC16245ABX	–40 °C to +125 °C	HXQFN60	plastic compatible thermal enhanced extremely	SOT1134-2						
74LVCH16245ABX			thin quad flat package; no leads; 60 terminals; body $4\times6\times0.5$ mm							

4. Functional diagram

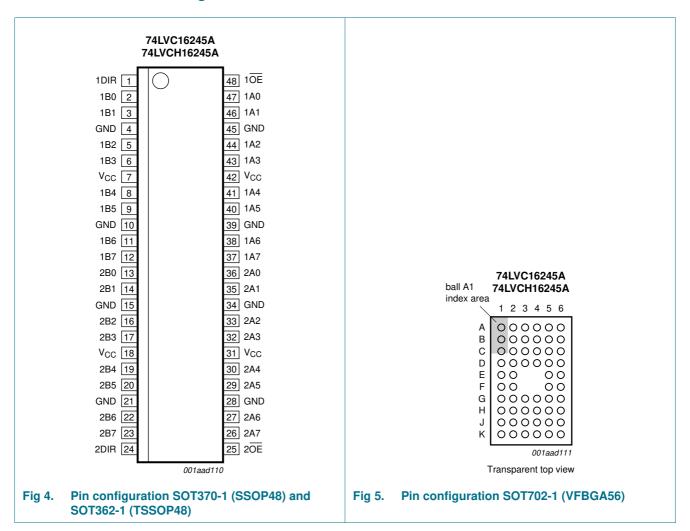






5. Pinning information

5.1 Pinning



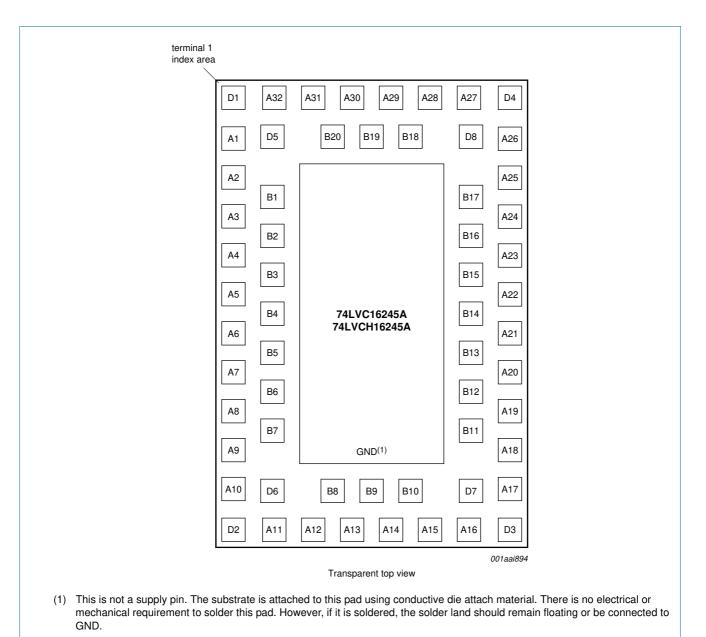


Fig 6. Pin configuration SOT1134-2 (HXQFN60)

5.2 Pin description

Table 2. Pin description

Symbol	Pin			Description
	SOT370-1 and SOT362-1	SOT702-1	SOT1134-2	_
1DIR, 2DIR	1, 24	A1, K1	A30, A13	direction control input
1B0 to 1B7	2, 3, 5, 6, 8, 9, 11, 12	B2, B1, C2, C1, D2, D1, E2, E1	B20, A31, D5, D1, A2, B2, B3, A5	data input/output
2B0 to 2B7	13, 14, 16, 17, 19, 20, 22, 23	F1, F2, G1, G2, H1, H2, J1, J2	A6, B5, B6, A9, D2, D6, A12, B8	data input/output
GND	4, 10, 15, 21, 28, B3, B4, D3, D4, G3, G4, 34, 39, 45 J3, J4		A32, A3, A8, A11, A16, A19, A24, A27	ground (0 V)
V _{CC}	7, 18, 31, 42	C3, C4, H3, H4	A1, A10, A17, A26	supply voltage
10E, 20E	48, 25	A6, K6	A29, A14	output enable input (active LOW)
1A0 to 1A7	47, 46, 44, 43, 41, 40, 38, 37	B5, B6, C5, C6, D5, D6, E5, E6	B18, A28, D8, D4, A25, B16, B15, A22	data input/output
2A0 to 2A7	36, 35, 33, 32, 30, 29, 27, 26	F6, F5, G6, G5, H6, H5, J6, J5	A21, B13, B12, A18, D3, D7, A15, B10	data input/output
n.c.	-	A2, A3, A4, A5, K2, K3, K4, K5	A4, A7, A20, A23, B1, B4, B7, B9, B11, B14, B17, B19	not connected

6. Functional description

Table 3. Function table[1]

Inputs nOE		Outputs					
nOE	nDIR	nAn	nBn				
L	L	nAn = nBn	inputs				
L	Н	inputs	nBn = nAn				
Н	X	Z	Z				

^[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input clamping current	$V_I < 0 V$	–50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
lok	output clamping current	$V_O > V_{CC}$ or $V_O < 0 V$	-	±50	mA
V_{O}	output voltage	output HIGH or LOW	<u>[2]</u> –0.5	$V_{CC} + 0.5$	V
		output 3-state	<u>[2]</u> –0.5	+6.5	V
lo	output current	$V_O = 0 V \text{ to } V_{CC}$	-	±50	mA
I _{CC}	supply current		-	100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		- 65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C};$			
		(T)SSOP48 package	<u>[3]</u> _	500	mW
		VFBGA56 package	<u>[4]</u> -	1000	mW
		HXQFN60 package	[4] -	1000	mW

^[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{CC}	supply voltage		1.65	-	3.6	V
		functional	1.2	-	3.6	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	output HIGH or LOW	0	-	V_{CC}	V
		output 3-state	0	-	5.5	V
T _{amb}	ambient temperature	in free air	-40	-	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{CC} = 1.2 \text{ V to } 2.7 \text{ V}$	0	-	20	ns/V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	0	-	10	ns/V

^[2] The output voltage ratings may be exceeded if the output current ratings are observed.

^[3] Above 60 °C the value of Ptot derates linearly with 5.5 mW/K.

^[4] Above 70 °C the value of P_{tot} derates linearly with 1.8 mW/K.

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40 °	°C to +8	5 ℃	-40 °C to	–40 °C to +125 °C		
			Min	Typ[1]	Max	Min	Max	1	
V_{IH}	HIGH-level input	V _{CC} = 1.2 V	1.08	-	-	1.08	-	V	
	voltage	V _{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V	
		V _{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V	
		V _{CC} = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V	
V_{IL}	LOW-level input	V _{CC} = 1.2 V	-	-	0.12	-	0.12	V	
	voltage	V _{CC} = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V	
		V _{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V	
		V _{CC} = 2.7 V to 3.6 V	-	-	8.0	-	0.8	V	
V_{OH}	HIGH-level	$V_I = V_{IH}$ or V_{IL}							
	output voltage	$I_O = -100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$	$V_{CC}-0.2$	-	-	$V_{CC}-0.3$	-	V	
		$I_O = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V	
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V	
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V	
		$I_O = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V	
		$I_O = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V	
V_{OL}	LOW-level output	$V_I = V_{IH}$ or V_{IL}							
	voltage	$I_O = 100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$	-	-	0.2	-	0.3	V	
		$I_O = 4 \text{ mA}$; $V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V	
		$I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	8.0	V	
		$I_O = 12 \text{ mA}$; $V_{CC} = 2.7 \text{ V}$	-	-	0.4	-	0.6	V	
		$I_O = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V	
II	input leakage current ^[2]	$V_I = 5.5 \text{ V or GND};$ $V_{CC} = 3.6 \text{ V}$	-	±0.1	±5	-	±20	μА	
l _{OZ}	OFF-state output current[2][3]	$V_I = V_{IH}$ or V_{IL} ; $V_O = 5.5$ V or GND; $V_{CC} = 3.6$ V	-	±0.1	±5	-	±20	μΑ	
I _{OFF}	power-off leakage current	V_{I} or $V_{O} = 5.5$ V; $V_{CC} = 0.0$ V	-	±0.1	±10	-	±20	μΑ	
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 3.6$ V	-	0.1	20	-	80	μΑ	
ΔI_{CC}	additional supply current	per input pin; $V_I = V_{CC} - 0.6 \text{ V}$; $I_O = 0 \text{ A}$; $V_{CC} = 2.7 \text{ V}$ to 3.6 V	-	5	500	-	5000	μА	
C _I	input capacitance	$V_{CC} = 0 \text{ V to } 3.6 \text{ V};$ $V_{I} = \text{GND to } V_{CC}$	-	5.0	-	-	-	pF	
C _{I/O}	input/output capacitance	$V_{CC} = 0 \text{ V to } 3.6 \text{ V};$ $V_{I} = \text{GND to } V_{CC}$	-	10	-	-	-	pF	

74LVC_LVCH16245A

 Table 6.
 Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +85	°C	–40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
I_{BHL}	bus hold LOW	$V_{CC} = 1.65; V_I = 0.58 V$	10	-	-	10	-	μΑ
	current [4][5]	$V_{CC} = 2.3; V_I = 0.7 V$	30	-	-	25	-	μΑ
		$V_{CC} = 3.0; V_1 = 0.8 \text{ V}$	75	-	-	60	-	μΑ
I _{BHH}	bus hold HIGH	$V_{CC} = 1.65; V_I = 1.07 V$	-10	-	-	-10	-	μΑ
	current [4][5]	$V_{CC} = 2.3; V_I = 1.7 V$	-30	-	-	-25	-	μΑ
		$V_{CC} = 3.0; V_{I} = 2.0 \text{ V}$	-75	-	-	-60	-	μΑ
I _{BHLO}	bus hold LOW	V _{CC} = 1.95 V	200	-	-	200	-	μΑ
	overdrive current [4][6]	V _{CC} = 2.7 V	300	-	-	300	-	μΑ
	15161	V _{CC} = 3.6 V	500	-	-	500	-	μΑ
I _{BHHO}	bus hold HIGH	V _{CC} = 1.95 V	-200	-	-	-200	-	μΑ
	overdrive current	V _{CC} = 2.7 V	-300	-	-	-300	-	μΑ
	<u>[4][6]</u>	V _{CC} = 3.6 V	-500	-	-	-500	-	μΑ

^[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 9.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C to	+125 °C	Unit
				Min	Typ[2]	Max	Min	Max	
t_{pd}	propagation	nAn to nBn; nBn to nAn; see Figure 7	[1]						
delay		V _{CC} = 1.2 V		-	13.0	-	-	-	ns
		V _{CC} = 1.65 V to 1.95 V		1.5	5.2	12.2	1.5	13.8	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.0	2.8	6.0	1.0	6.7	ns
	V _{CC} = 2.7 V			1.0	2.7	4.7	1.0	6.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	2.4	4.5	1.0	6.0	ns
t _{en}	enable time	nOE to nAn, nBn; see Figure 8	[1]						
		$V_{CC} = 1.2 \text{ V}$		-	15.0	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.5	5.9	15.0	1.5	16.9	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.0	3.3	7.9	1.0	8.8	ns
		V _{CC} = 2.7 V		1.5	3.5	6.7	1.5	8.5	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	2.7	5.5	1.0	7.0	ns

^[2] The bus hold circuit is switched off when $V_I > V_{CC}$ allowing 5.5 V on the input terminal.

^[3] For I/O ports the parameter I_{OZ} includes the input leakage current.

^[4] Valid for data inputs of bus hold parts only (74LVCH16245A). Note that control inputs do not have a bus hold circuit.

^[5] The specified sustaining current at the data input holds the input below the specified V_1 level.

^[6] The specified overdrive current at the data input forces the data input to the opposite input state.

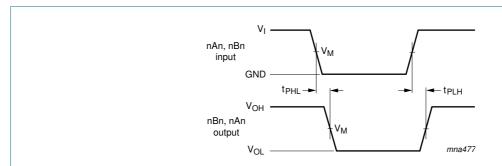
Table 7. Dynamic characteristics ... continued

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 9.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C to	+125 °C	Unit
				Min	Typ[2]	Max	Min	Max	
t_{dis}	disable time	nOE to nAn, nBn; see Figure 8	[1]						
		V _{CC} = 1.2 V		-	11.0	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.0	4.9	13.1	1.0	14.7	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		0.5	2.7	7.1	0.5	7.9	ns
		$V_{CC} = 2.7 \text{ V}$		1.5	3.4	6.6	1.5	8.5	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.5	3.3	5.6	1.5	7.0	ns
C _{PD}	power	per input; $V_I = GND$ to V_{CC}	[3]						
	dissipation capacitance	$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		-	11.5	-	-	-	pF
	capacitance	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		-	15.2	-	-	-	pF
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		-	18.5	-	-	-	pF

- [1] t_{pd} is the same as t_{PLH} and t_{PHL} .
 - t_{en} is the same as t_{PZL} and t_{PZH} .
 - t_{dis} is the same as t_{PLZ} and t_{PHZ} .
- [2] Typical values are measured at $T_{amb} = 25$ °C and $V_{CC} = 1.2$ V, 1.8 V, 2.5 V, 2.7 V and 3.3 V respectively.
- [3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).
 - $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where:
 - f_i = input frequency in MHz; f_o = output frequency in MHz
 - C_L = output load capacitance in pF
 - V_{CC} = supply voltage in Volts
 - N = number of inputs switching
 - $\Sigma(C_L \times V_{CC}^2 \times f_0) = \text{sum of the outputs.}$

11. Waveforms



Measurement points are given in Table 8.

Logic levels: V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig 7. The input (nAn, nBn) to output (nBn, nAn) propagation delays

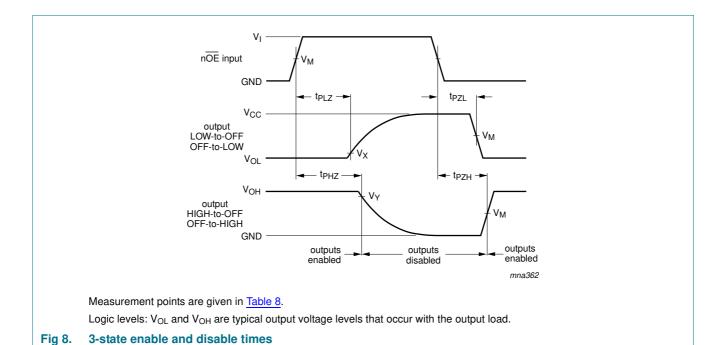
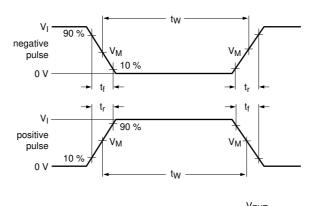
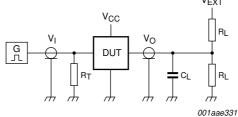


Table 8. Measurement points

Supply voltage	V _M	Input	put								
V _{CC}		VI	$t_r = t_f$	V _X	V _Y						
1.2 V	$0.5 \times V_{CC}$	V _{CC}	≤ 2.5 ns	$V_{OL} + 0.15 V$	$V_{OH}-0.15\ V$						
1.65 V to 1.95 V	$0.5 \times V_{CC}$	V_{CC}	≤ 2.5 ns	V _{OL} + 0.15 V	$V_{OH}-0.15\ V$						
2.3 V to 2.7 V	$0.5 \times V_{CC}$	V_{CC}	≤ 2.5 ns	V _{OL} + 0.15 V	$V_{OH}-0.15\ V$						
2.7 V	1.5 V	2.7 V	≤ 2.5 ns	$V_{OL} + 0.3 V$	$V_{OH}-0.3\ V$						
3.0 V to 3.6 V	1.5 V	2.7 V	≤ 2.5 ns	$V_{OL} + 0.3 V$	$V_{OH}-0.3\ V$						





Test data is given in Table 9.

Definitions for test circuit:

R_L = Load resistance.

C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to output impedance Z_0 of the pulse generator.

V_{EXT} = External voltage for measuring switching times.

Fig 9. Test circuit for measuring switching times

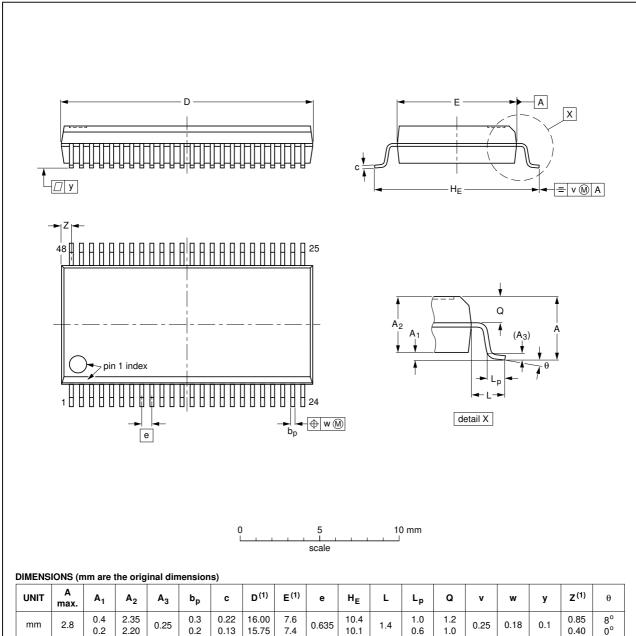
Table 9. Test data

Supply voltage	Input		Load		V _{EXT}	V _{EXT}				
	V_{l} t_{r} , t_{f} C_{L} R_{L}		t _{PLH} , t _{PHL}	t_{PLZ} , t_{PZL}	t _{PHZ} , t _{PZH}					
1.2 V	V_{CC}	≤ 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND			
1.65 V to 1.95 V	V_{CC}	≤ 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND			
2.3 V to 2.7 V	V_{CC}	≤ 2 ns	30 pF	500Ω	open	$2\times V_{CC}$	GND			
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500Ω	open	$2\times V_{CC}$	GND			
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500Ω	open	$2\times V_{CC}$	GND			

12. Package outline

SSOP48: plastic shrink small outline package; 48 leads; body width 7.5 mm

SOT370-1



UNIT	A max.	A ₁	A ₂	A ₃	b _p	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	2.8	0.4 0.2	2.35 2.20	0.25	0.3 0.2	0.22 0.13	16.00 15.75	7.6 7.4	0.635	10.4 10.1	1.4	1.0 0.6	1.2 1.0	0.25	0.18	0.1	0.85 0.40	8° 0°

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

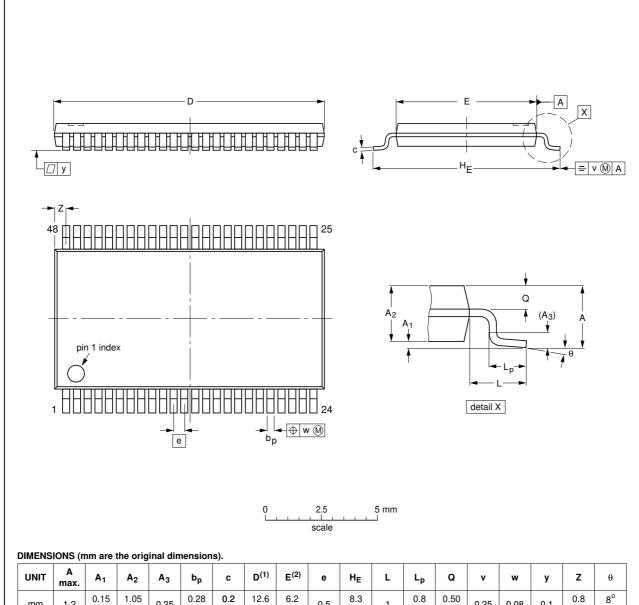
OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT370-1		MO-118				99-12-27 03-02-19

Fig 10. Package outline SOT370-1 (SSOP48)

74LVC_LVCH16245A

TSSOP48: plastic thin shrink small outline package; 48 leads; body width 6.1 mm

SOT362-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽²⁾	е	HE	L	Lp	Q	v	w	у	z	θ
mm	1.2	0.15 0.05	1.05 0.85	0.25	0.28 0.17	0.2 0.1	12.6 12.4	6.2 6.0	0.5	8.3 7.9	1	0.8 0.4	0.50 0.35	0.25	0.08	0.1	0.8 0.4	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

	REFER	EUROPEAN	ISSUE DATE		
IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
	MO-153				-99-12-27 03-02-19
	IEC	IEC JEDEC		IEC JEDEC JEITA	IEC JEDEC JEITA PROJECTION

Fig 11. Package outline SOT362-1 (TSSOP48)

74LVC_LVCH16245A

All information provided in this document is subject to legal disclaimers.

© NXP B.V. 2012. All rights reserved.

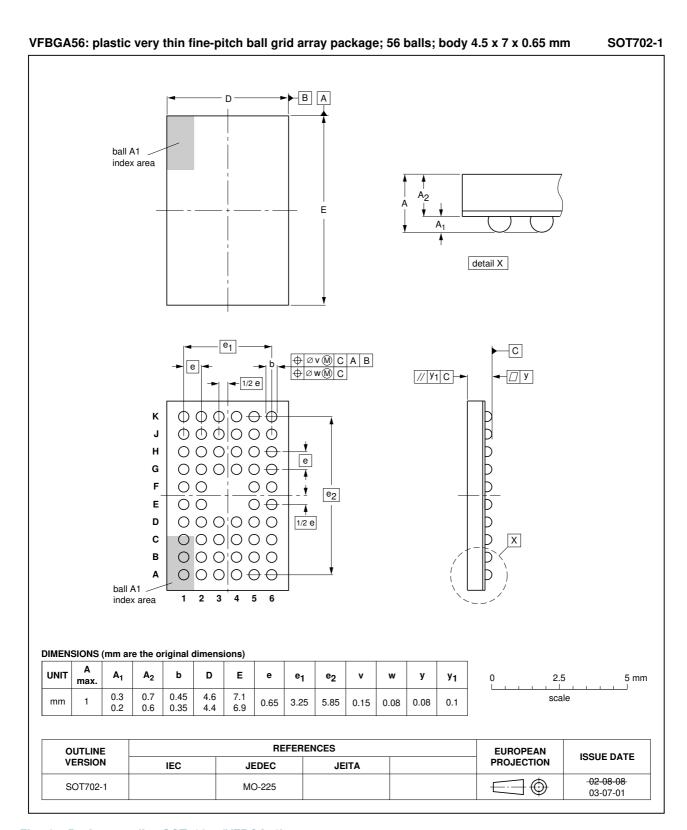


Fig 12. Package outline SOT702-1 (VFBGA56)

74LVC_LVCH16245A

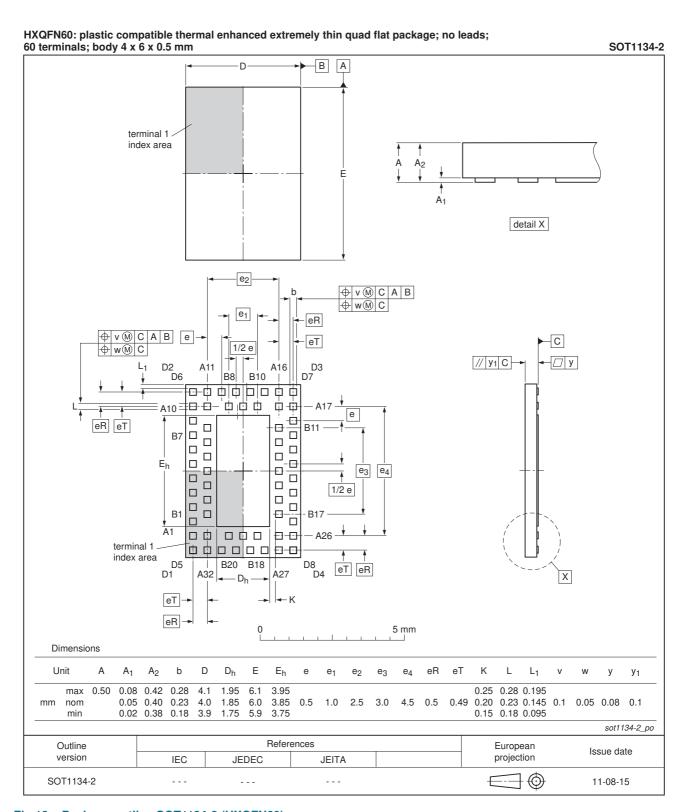


Fig 13. Package outline SOT1134-2 (HXQFN60)

74LVC_LVCH16245A

All information provided in this document is subject to legal disclaimers.

© NXP B.V. 2012. All rights reserved.

13. Abbreviations

Table 10. Abbreviations

Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

14. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC_LVCH16245A v.12	20120213	Product data sheet	-	74LVC_LVCH16245A v.11
Modifications:	 For type num SOT1134-2. 	ber 74LVC16245ABX and	d 74LVCH16245ABX	the sot code has changed to
74LVC_LVCH16245A v.11	20111208	Product data sheet	-	74LVC_LVCH16245A v.10
Modifications:	• Table 4, Table	<u>5, Table 6, Table 7,</u> and	Table 9: values adde	d for lower voltage ranges.
74LVC_LVCH16245A v.10	20110623	Product data sheet	-	74LVC_LVCH16245A v.9
Modifications:	 type numbers and 74LVCH1 		4LVCH16245ABQ ch	nanged to 74LVC16245ABX
	• Figure 6: figure	re note 1 changed.		
74LVC_LVCH16245A v.9	20100329	Product data sheet	-	74LVC_LVCH16245A v.8
74LVC_LVCH16245A v.8	20081106	Product data sheet	-	74LVC_LVCH16245A v.7
74LVC_LVCH16245A v.7	20031125	Product specification	-	74LVC_LVCH16245A v.6
74LVC_LVCH16245A v.6	20030130	Product specification	-	74LVC_LVCH16245A v.5
74LVC_LVCH16245A v.5	20021030	Product specification	-	74LVC_H16245A v.4
74LVC_H16245A v.4	19970925	Product specification	-	74LVC16245A_ 74LVCH16245A v.3
74LVC16245A_ 74LVCH16245A v.3	19970925	Product specification	-	74LVC16245A v.2
74LVC16245A v.2	19970801	Product specification	-	74LVC16245A v.1
74LVC16245A v.1	-	-	-	-

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

15.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

15.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. NXP Semiconductors takes no responsibility for the content in this document if provided by an information source outside of NXP Semiconductors.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors and its suppliers accept no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

74LVC_LVCH16245A

74LVC16245A; 74LVCH16245A

16-bit bus transceiver with direction pin; 5 V tolerant; 3-state

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Non-automotive qualified products — Unless this data sheet expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond

NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

Translations — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

15.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

16. Contact information

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

NXP Semiconductors

74LVC16245A; 74LVCH16245A

16-bit bus transceiver with direction pin; 5 V tolerant; 3-state

17. Contents

1	General description	1
2	Features and benefits	1
3	Ordering information	2
4	Functional diagram	2
5	Pinning information	4
5.1	Pinning	4
5.2	Pin description	6
6	Functional description	6
7	Limiting values	7
8	Recommended operating conditions	7
9	Static characteristics	8
10	Dynamic characteristics	ę
11	Waveforms	1(
12	Package outline	13
13	Abbreviations	17
14	Revision history	17
15	Legal information 1	18
15.1	Data sheet status	18
15.2	Definitions1	
15.3	Disclaimers	
15.4	Trademarks1	16
16	Contact information	16
17	Contents	'n

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.